

# 32.768kHz CONTINUOUS VOLTAGE SMD CRYSTAL XO



**ASDKDV**

Request Samples



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ESD Sensitive



2.5 x 2.0 x 1.0 mm

RoHS/RoHS II Compliant

MSL Level = N/A

## Features

- Continuous Vdd operation from 1.62 V ~ 3.63 V
- Optimized for low current consumption
- Output Enable/Start & Disable/Stop function
- Output waveform CMOS/LVCMOS compatible
- Hermetically seam-sealed ceramic package

## Applications

- Portable & wearable electronics
- Internet of Things (IoT)
- Consumer electronics
- Industrial control & automation
- Mobile communication

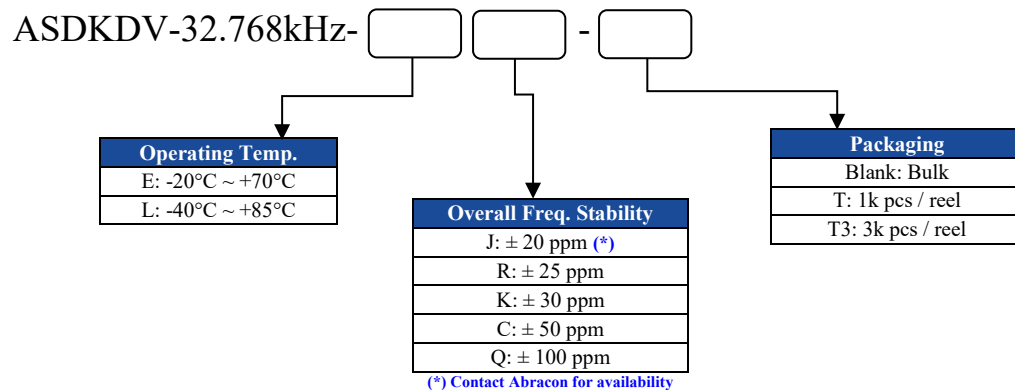
## Electrical Specifications

Parameters	Min.	Typ.	Max.	Units	Notes
Frequency		32.768		kHz	
Operating Temperature Range	-40.0		+85	°C	See options
Storage Temperature Range	-55.0		+125	°C	
Overall Frequency Stability [Note 1]	-25.0		+25	ppm	See options
Supply Voltage (Vdd)	+1.62		+3.63	V	
Tri-state function [Note 2]	“1” (VIH≥0.7*Vdd) or Open: Oscillation; “0” (VIL<0.3*Vdd): No Oscillation/Hi Z			V	
Output Load			15	pF	CMOS
Output Voltage	V <sub>OH</sub>	0.9*Vdd		V	
	V <sub>OL</sub>		0.1*Vdd		
Aging 1 year @25°C±3°C	-3.0		+3.0	ppm	
Aging 5 years @25°C±3°C	-5.0		+5.0	ppm	
Symmetry @ ½ Vdd	45	50	55	%	
Start-up Time			10	ms	
Rise and Fall Time (Tr/Tf) @10%Vdd-90%Vdd, 15pF load			30	ns	
Disable Current			5	µA	
Supply Current (Idd) @25°C±3°C	Vdd = 3.3V	10	15	µA	No Load
	Vdd = 2.5V	9	14	µA	No Load
	Vdd = 1.8V	8	13	µA	No Load

**Note 1:** Overall frequency stability includes initial frequency tolerance @25°C±3°C and stability over the operating temperature range.

**Note 2:** Do not leave pin 1 (INH) floating. If pin 1 (INH) is not utilized for toggling, it must be tied to Vdd (logic 1).

## Part Identification



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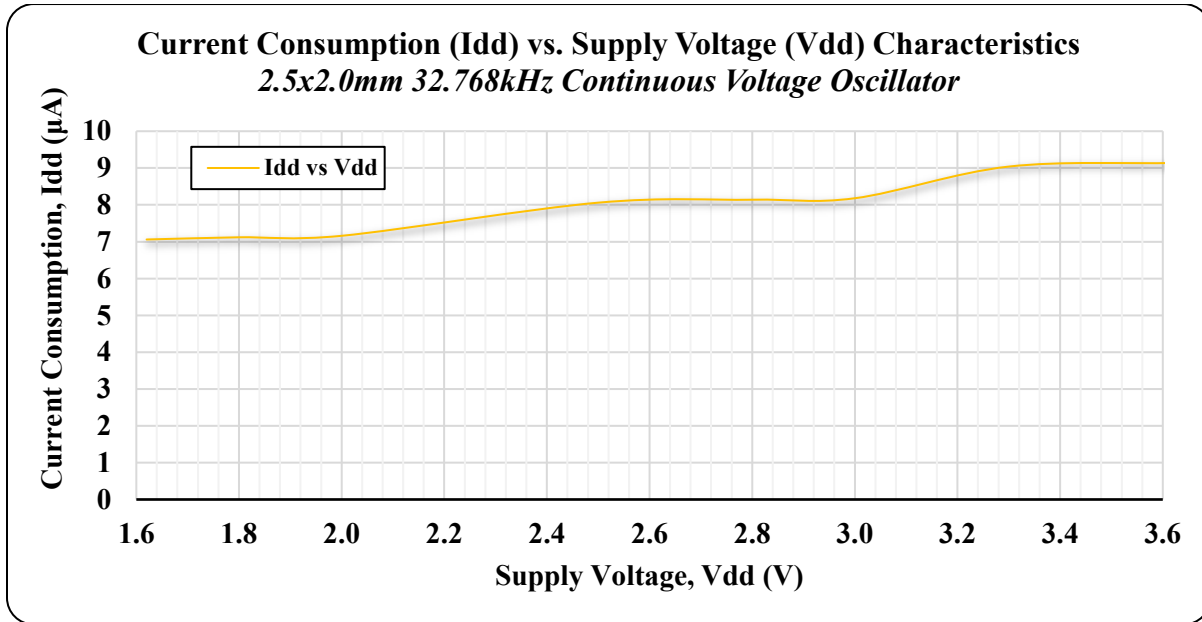


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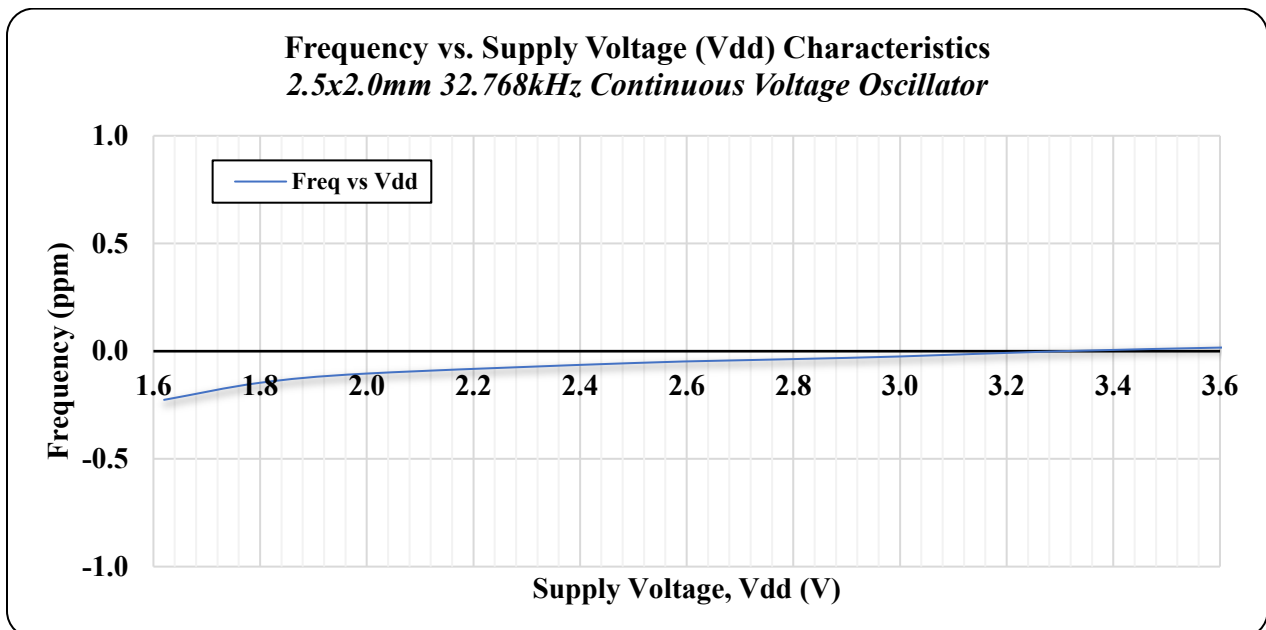


2.5 x 2.0 x 1.0 mm  
RoHS/RoHS II Compliant  
MSL Level = N/A

## Typical Current Consumption (I<sub>dd</sub>) vs. Supply Voltage (V<sub>dd</sub>) Characteristics [ @ 25°C ± 3°C, No Load ]



## Typical Frequency vs. Supply Voltage (V<sub>dd</sub>) Characteristics [ @ 25°C ± 3°C, Normalized to V<sub>dd</sub>=3.3Vdc ]



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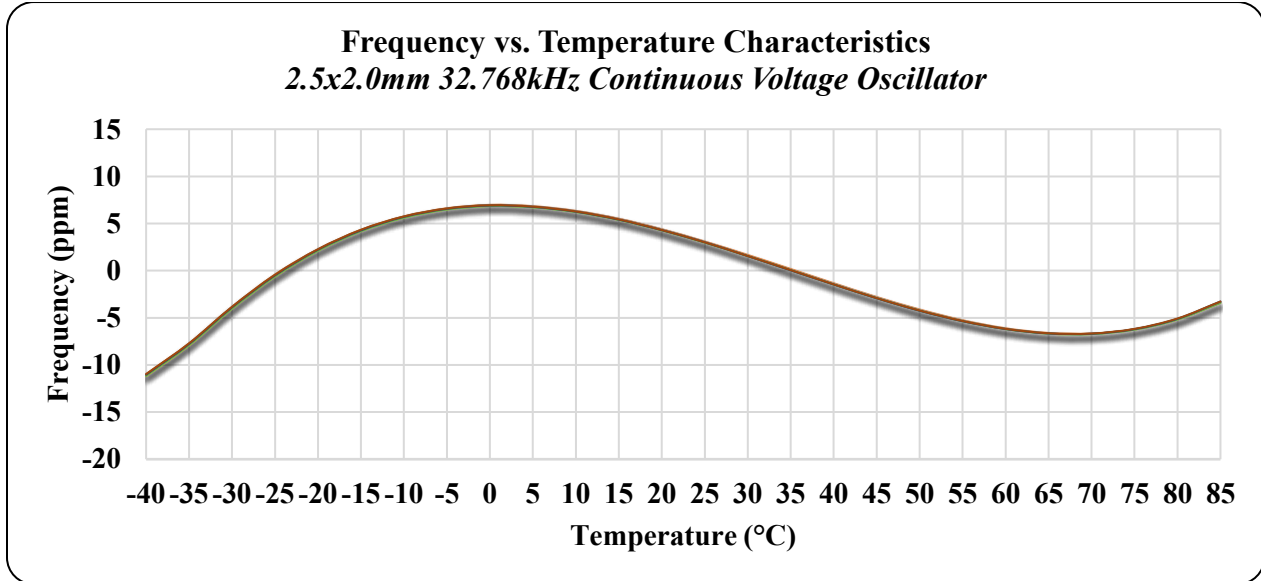


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## Typical Frequency vs. Temperature Characteristics



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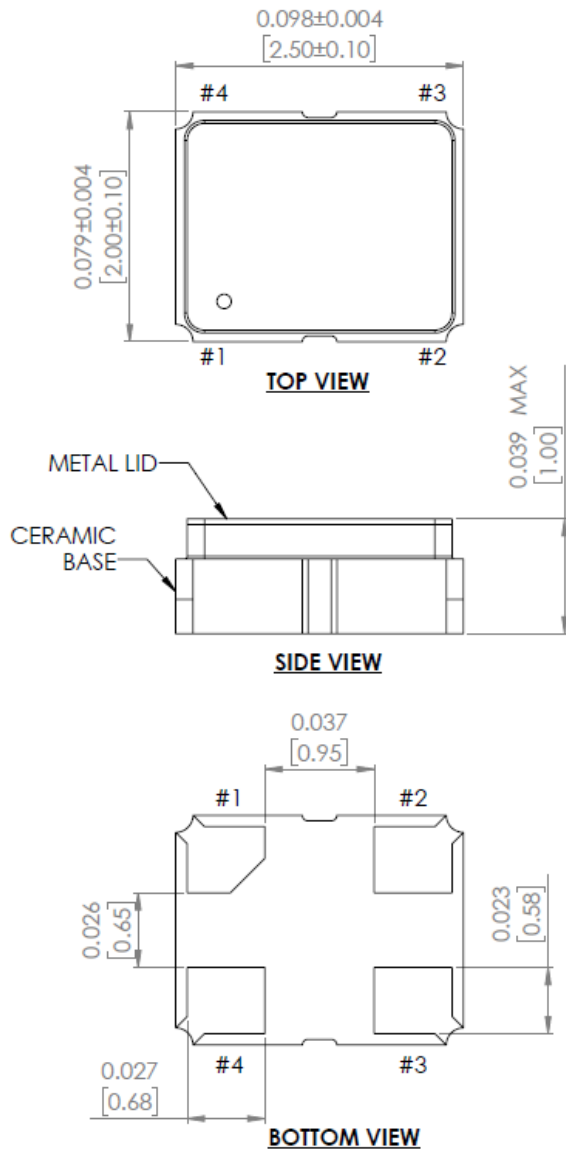


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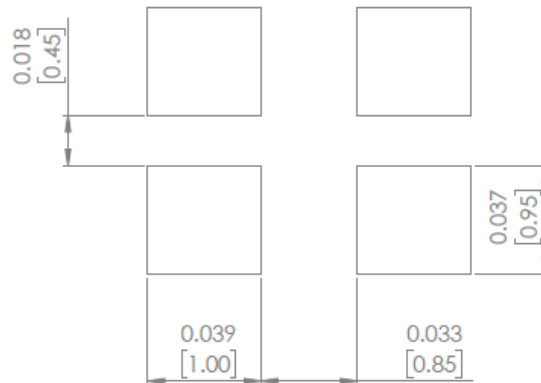


2.5 x 2.0 x 1.0 mm  
**RoHS/RoHS II Compliant**  
 MSL Level = N/A

## Mechanical Dimensions



## Recommended Land Pattern



Pin #	Function
1	INH
2	GND
3	Output
4	Vdd

INH Function	
#1	#3 (Output)
Open	Active
"H" Level	Active
"L" Level	High Z (No Oscillation)

**Note 3:**

- Do not leave Pin 1 (INH) floating
- If Pin 1 (INH) is not utilized for toggling, it must be tied to Vdd (logic 1)

**Note 4:**

Recommended to use approximately 0.01µF bypass capacitor between PIN 2 and PIN 4

Dimensions: inches (mm)



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## Reflow Profile [JDEC J-STD-020]

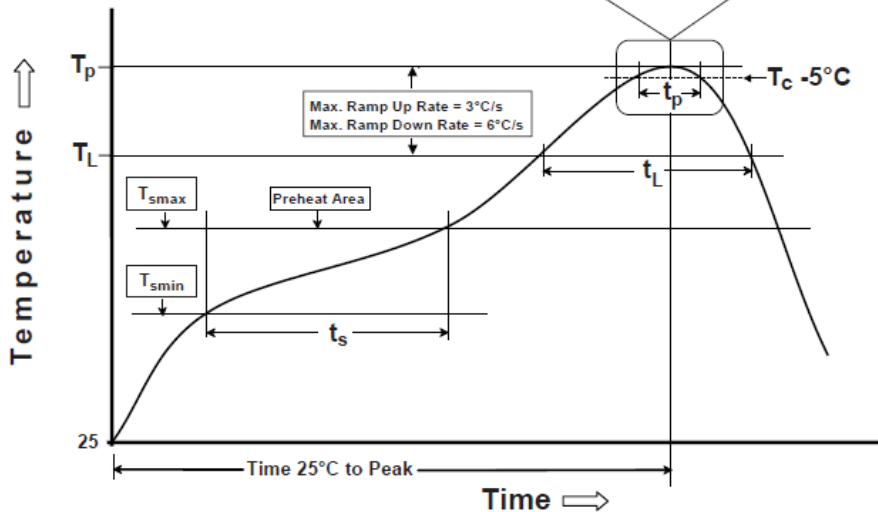
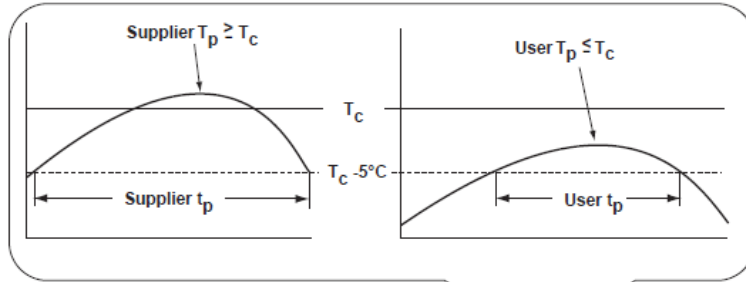


Table 1

### SnPb Eutectic Process Classification Temperatures (T<sub>c</sub>)

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2

### Pb-Free Process Classification Temperatures (T<sub>c</sub>)

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm - 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat / soak		
Temperature minimum (T <sub>smin</sub> )	100°C	150°C
Temperature maximum (T <sub>smax</sub> )	150°C	200°C
Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60 - 120 sec.	60 - 120 sec.
Average ramp-up rate (T <sub>smax</sub> to T <sub>p</sub> )	3°C/sec. max	3°C/sec. max
Liquidous temperature (T <sub>L</sub> )	183°C	217°C
Time at liquidous (t <sub>L</sub> )	60 - 150 sec.	60 - 150 sec.
Peak package body temperature (T <sub>p</sub> )*	see Table 1	see Table 2
Time (t <sub>p</sub> )** within 5°C of the specified classification temperature (T <sub>c</sub> )	20 sec.	30 sec.
Ramp-down rate (T <sub>p</sub> to T <sub>smax</sub> )	6°C/sec. max	6°C/sec. max
Time 25°C to peak temperature	6 min. max	8 min. max

\*Tolerance for peak profile temperature (T<sub>p</sub>) is defined as a supplier minimum and a user maximum.

\*\*Tolerance for time at peak profile temperature (t<sub>p</sub>) is defined as supplier minimum and a user maximum.



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